Power Management Texas Instruments

Battery-charging considerations for high-power portable devices

By Tahar Allag System Engineer Wenjia Liu Applications Engineer

Introduction

Cell phones are a good example of how functionality and performance have both increased significantly in portable devices over the last few decades. They have become more complex and can do many basic tasks as well as any computer. The extra functionality that has transitioned the smartphone from a phone-call-only device to a multipurpose portable device, which makes it more power hungry than ever before.

The internal battery pack is the main source of storing and delivering power to portable-device circuitry. Battery-charger ICs are responsible for charging the battery pack safely and efficiently. They must also control the power delivery to the system to maintain normal operation while plugged in to wall power. The battery pack is required to store a large amount of energy and be charged in a short amount of time without sacrificing weight and volume. The increased charge and discharge currents, as well as the smaller physical size, make the packs vulnerable to physical and thermal stresses. Therefore, battery chargers are no longer required to perform just as a simple standalone charger.

To maintain reasonable charge times and safe charging conditions, a battery-charger IC is required to be flexible because it must guarantee power to the system at all times and provide proper protection for both the battery and system. This article explores single-cell battery-charger solutions and includes a detailed discussion about the performance and constraints of chargers for compact high-power applications.

An overview of single-cell charging solutions

Rechargeable batteries are vital to portable electronic devices such as cell phones and wearable electronics. Charging circuits must be carefully designed and are highly dependent on three factors: battery chemistry, power levels, and system load. Different battery chemistries require different charging methods. An application's power requirements directly impact the charging system's

cost and size. Finally, the system power requirement must be considered to determine the necessity of a power-path versus a non-power-path system.

Lithium-Ion (Li-Ion) batteries are becoming the chemistry of choice for many portable applications for several reasons. They offers a high capacity-to-size and weight ratio, and they have low self-discharge characteristics. They also have high cell-voltage characteristics, typically 3.6 V, which allows a battery pack to be designed with only one-cell. Despite all these advantages, Li-Ion batteries are fragile to stress. They require many special considerations regarding charge current, regulation voltage, trickle charge levels, temperature monitoring, and so on.

There are two basic types of charging methods: linear and switch-mode charging. Switch-mode charging minimizes power dissipation over a wide range of AC-adapter voltages, but consumes more board space and adds complexity. Additionally, switch-mode applications generally are higher cost than an equivalent linear application.

Linear chargers are smaller and great for noise-sensitive equipment. However, they are not as efficient across the entire charge cycle as their switch-mode counterparts. When selecting a charging method, the designer makes the decision by prioritizing cost, space, bill-of-material (BOM) count, and efficiency (thermal loading).

The variety of system requirements drive many different battery-charger solutions; from a simple standalone charger to an embedded charger that also provides system power. System requirements include, but are not limited to:

- The need for dynamic power path management (DPPM) that guarantees system instant-on with discharged or disconnected battery.
- \bullet Low FET $R_{DS(on)}$ for both the battery and system path to guarantee acceptable overall system efficiency and thermal management.
- High charge current to support high-capacity battery packs and shorten the charge time.
- Input-voltage dynamic power management (DPM) that supports the limitation of any adapter and/or USB port.

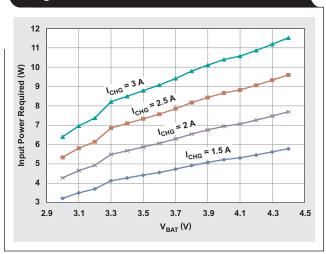
Texas Instruments Power Management

Compact single-cell charger applications

Power requirements (adapter limitation)

Currently, most smartphone adapters are specified for 5- to 10-W maximum output power. Figure 1 shows the input power needed from the USB port or adapter for different charging current levels. For a 1.5-A charge current, the required power increases linearly from 3 W to 5 W as the battery voltage increases from 3 V to full charge. For a 3-A charge rate, up to 12 W is needed from the input during the charge cycle. In this scenario, depending on the battery's state of charge, a 5-W or 10-W adapter can crash and the system collapses. To prevent this from happening, the charger is required to have some kind of protection to reduce the power drawn from the input.

Figure 1. Input power needed for different charge currents



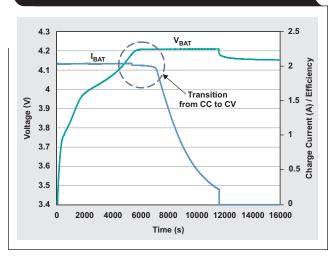
A battery charger such as the bq24250 from Texas Instrument has dynamic power management (DPM) that monitors input voltage ($V_{\rm IN_DPM}$). During the normal charging process, if the input power source is not able to support the programmed or default charging current, the input voltage decreases. If the input voltage drops to the $V_{\rm IN_DPM}$ threshold set by the designer, the charge current is reduced. This limits the power drawn from the input supply and prevents further drop of the input voltage. This feature ensures IC compatibility with adapters that have different current capabilities without any hardware change.

Charge time

As described earlier, charge time depends on the battery capacity and charge rate. The easiest way to decrease charge time is to charge at a faster rate. However, charging a battery with higher than 80% (0.8C) of the battery's full capacity causes stress on the battery. This decreases its lifetime or possibly damages the pack with catastrophic results. Texas Instruments has developed charge-time optimization of charge cycles to reduce charge time for a given charge rate compared to other solutions.

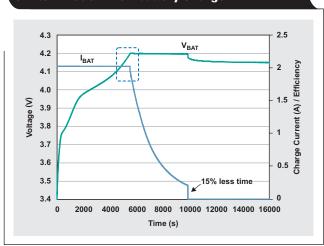
The charge cycle of Li-Ion batteries is mainly composed of three phases: pre-charger (trickle), fast charge (constant current), and taper (constant voltage). The transition between one phase to another is not ideal for many switch-mode chargers. Figure 2 highlights the phase transition from constant current to constant voltage in a legacy charger circuit. Both voltage and current do not have a sharp transition. This behavior causes both time and power loses during the charge cycle.

Figure 2: Charge cycle of a legacy charger without time-optimizer technology



A Li-Ion battery charger from Texas Instruments improves this transition using the time-optimizer technology. Figure 3 shows a charge cycle of the same battery and under the same charging conditions as in Figure 2. The charge time is reduced by more than 15%. The transition is much sharper on the new charger, which spends more time in the fast-charge (CC) phase before transitioning into the taper (CV) phase. This puts more Coulombs into the pack at a faster rate, thereby reducing the charge time without increasing the charge rate.

Figure 3: Time-optimized charge cycle for a switch-mode Li-lon battery charger



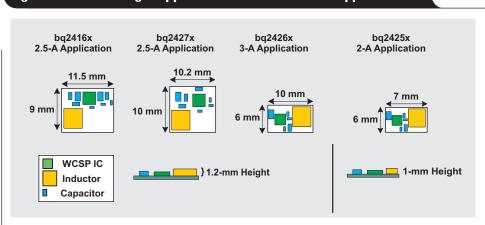


Figure 4: DPPM charger application area for different applications

Board size and BOM cost

For higher charge rates, linear chargers become less attractive. Their reduced efficiency over the charge cycle increases thermal loading on the system. This is especially true in size-constrained boards and high-power applications. These conditions drive the requirement for a fully-integrated switch-mode charger.

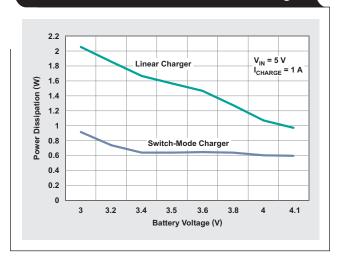
Vendors such as Texas Instrument are pushing the envelope of innovation to meet market demand by reducing the BOM cost and board space without sacrificing device performance. For example, the bq24250 is a highly-integrated single-cell Li-Ion battery charger and system power-path management IC targeted for space-limited, portable applications with high-capacity batteries. Figure 4 shows a range of devices with actual application area size. For instance, the bq2425x family of chargers can provide a charge current of up to 2 A, an economical BOM, and a 42-mm² application area.

Thermal performance and efficiency

Reducing the size of the charger area affects the thermal performance of the whole board. Less available area results in less space to dissipate the heat caused by the power dissipated during charging. For a given board area, the only way to reduce thermal loading is to improve charger efficiency during power conversion. Higher efficiency results in lower power dissipation. Thus, less heat is generated from the IC and the board.

When comparing power dissipation between linear and switch-mode chargers in higher power applications, linear chargers becomes less desirable as the power dissipated can be very high—especially for lower battery voltages. This is because the linear chargers use a linear regulator to do the power conversion. On the other hand,

Figure 5: Comparison of power dissipation between a linear versus switch-mode charger



switch-mode charging is much more efficient over the entire battery voltage range and results in less power dissipation. Figure 5 shows a comparison in power dissipation between linear and switch-mode chargers.

Choosing a switch-mode charger over a linear charger is a logical choice to improve charger thermal dissipation on the board. Lowering the $R_{\rm DS(on)}$ of the integrated FET inside the switch charger helps improve charger efficiency at high currents. This is because most power dissipation at higher currents for a switch charger is caused by the FET's $R_{\rm DS(on)}.$ The bq24250 Li-Ion battery charger has integrated power FETs with low $R_{\rm DS(on)}.$ Internal high-side and low-side MOSFETs are rated to only 100 m Ω each.

Texas Instruments Power Management

This helps reduce power dissipation from the input to system output. The $R_{\rm DS(on)}$ of the FET switch to the battery is only 20 m Ω . This also helps reduce losses during battery charging and discharging. Figure 6 provides system efficiency data for the bq24250, which can be as much as 95%.

Battery protection and battery-life extension

A major issue with the high-power portable electronics is battery life cycle. The reduction of battery capacity over time greatly impacts the user's experience by reducing runtime. The main contributor to improve the battery pack life cycle is to reduce stress during charge and discharge. Li-Ion batteries are very sensitive to stresses caused by overcurrent or overvoltage on the pack.

Battery-charger ICs such as the bq24250 can regulate the battery voltage with $\pm 0.5\%$ accuracy in room temperature. For charge current, this IC provides $\pm 0.75\%$ accuracy for up to 2-A charge current over the 0 to 125°C temperature range. This accuracy allows designers to precisely program the voltage and current level according to the application needs. With these accurate charging parameters, batteries can be charged more aggressively without reducing the life cycle. Thus, charge time is reduced while maintaining a safe charging solution.

Figure 7 shows the accuracy of three charge currents over temperatures ranging from 0° C to 125° C. For up to 1.5-A charge currents, accuracy is within 2% of the typical value shown in the datasheet.

System-off mode (SYSOFF)

During presale shipping and storage, the battery needs to be disconnected from the rest of the system to prevent depleting the battery. The bq24250 battery charger has a SYSOFF mode that can be set to turn off the battery FET and disconnect the battery from the system. When the SYSOFF mode is used, the leakage current from the battery into the IC is reduced to less than 1 μA (Figure 8). The designer programs the system to automatically exit SYSOFF mode when the end customer plugs a power supply into the charger.

Application flexibility

In today's highly competitive market, most players are constantly pursuing lower costs, which potentially can bring higher margins and greater competency. Being able to repurpose the same chip for various products or multiple generations has a direct cost savings for different system designs. It also shortens the application learning curve and avoids unnecessary risk by using a known working solution.

The market is pushing for a family of battery chargers that integrates several features to provide flexibility for different applications. One example is a charger with a wide input-voltage range so it is applicable for a broad range of adapters, which could potentially reduce inventory costs. The flexibility in charge currents can support the higher current for applications like power banks and smartphones as well as low-level charging to applications like $Bluetooth^{\otimes}$ headsets.

Figure 6: System efficiency of the bq24250 Li-Ion battery charger—4.2-V regulation

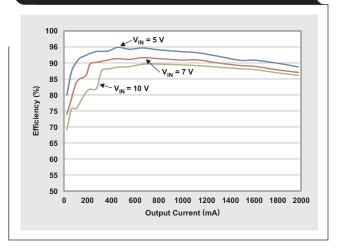


Figure 7: Charge current accuracy versus temperature

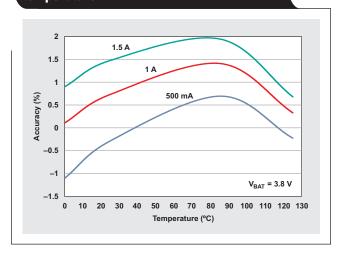
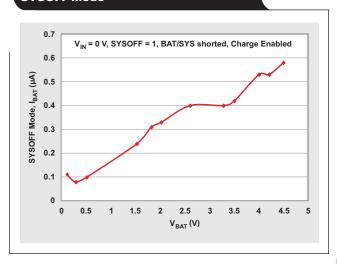


Figure 8: Battery leakage current in SYSOFF mode



Power Management Texas Instruments

Many chargers provide two chip-control schemes: I^2C communication and standalone. This allows the tailoring each application as needed. In I^2C mode, designers can program various parameters such as V_{IN_DPM} threshold, charge current, input current limit, regulation voltage, and termination level. When operating in standalone mode, where the host control is not desired, designers can use external settings to program the above parameters and utilize external pins to select different levels of input-current limit and to enable/disable the chip.

The BC1.2-compliant, D+/D- USB detection feature offers greater flexibility for more robust USB charging. In the past, USB charging was very straight forward where the device took power directly from the USB port to the battery with little control. In today's high-power applications, devices are requesting far more power from the USB port, which leads to more complicated standards and protocols being implemented. Furthermore, with the various USB standards normalized in the same USB port connector, the ability to recognize which type of device is connected is a very useful and competitive feature.

Conclusion

There are many options available for charging high-power portable devices. Currently available charging ICs that support power-path management and high charging current with improved efficiency can reduce charge time, thermal stress and solution size. A low-cost BOM and a small size solution bring the device cost down without sacrificing size and capability.

References

- Texas Instruments. "Reference Design for 2A Single Input I2C/Standalone Switch-Mode Li-Ion Battery Charger," Reference Design. Available: www.ti.com/2q14-tida00048
- Tahar Allag and James Smith, "Using bq2425x's DPM Feature for Solar Panel Applications," Application Report, July 2013. Available: www.ti.com/2q14-slua687
- Tahar Allag and James Smith, "Selecting the Best bq2425x Single Cell I2C, Standalone Switch-Mode Battery Charger for your Application," Application Report, June 2013. Available: www.ti.com/2q14-slua685

Related Web sites

www.ti.com/2q14-bq24251 www.ti.com/2q14-bq24251 www.ti.com/2q14-bq24253 www.ti.com/2q14-bq24257 Subscribe to the AAJ: www.ti.com/subscribe-aaj

TI Worldwide Technical Support

Internet

TI Semiconductor Product Information Center Home Page

support.ti.com

TI E2E™ Community Home Page

e2e.ti.com

Product Information Centers

Americas Phone +1(512) 434-1560

Brazil Phone 0800-891-2616

Mexico Phone 0800-670-7544

Fax +1(972) 927-6377

Internet/Email support.ti.com/sc/pic/americas.htm

Europe, Middle East, and Africa

Phone

European Free Call 00800-ASK-TEXAS

(00800 275 83927)

International +49 (0) 8161 80 2121 Russian Support +7 (4) 95 98 10 701

Note: The European Free Call (Toll Free) number is not active in all countries. If you have technical difficulty calling the free call number, please use the international number above.

Fax +(49) (0) 8161 80 2045
Internet www.ti.com/asktexas
Direct Email asktexas@ti.com

Japan

Fax International +81-3-3344-5317

Domestic 0120-81-0036

Internet/Email International support.ti.com/sc/pic/japan.htm

Domestic www.tij.co.jp/pic

Asia

Phone <u>Toll-Free Number</u>

Note: Toll-free numbers may not support

mobile and IP phones.

Australia 1-800-999-084
China 800-820-8682
Hong Kong 800-96-5941

India 000-800-100-8888 Indonesia 001-803-8861-1006

Korea080-551-2804Malaysia1-800-80-3973New Zealand0800-446-934Philippines1-800-765-7404Singapore800-886-1028Taiwan0800-006800

Thailand 001-800-886-0010

International +86-21-23073444 Fax +86-21-23073686

Email tiasia@ti.com or ti-china@ti.com Internet support.ti.com/sc/pic/asia.htm

Important Notice: The products and services of Texas Instruments Incorporated and its subsidiaries described herein are sold subject to TI's standard terms and conditions of sale. Customers are advised to obtain the most current and complete information about TI products and services before placing orders. TI assumes no liability for applications assistance, customer's applications or product designs, software performance, or infringement of patents. The publication of information regarding any other company's products or services does not constitute TI's approval, warranty or endorsement thereof.

A021014

E2E and OMAP are trademarks and DLP is a registered trademark of Texas Instruments. The *Bluetooth* word mark and logos are owned by the Bluetooth SIG, Inc., and any use of such marks by Texas Instruments is under license. All other trademarks are the property of their respective owners.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive Communications and Telecom Amplifiers amplifier.ti.com www.ti.com/communications **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** www.dlp.com Consumer Electronics www.ti.com/consumer-apps

DSP **Energy and Lighting** dsp.ti.com www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical logic.ti.com Logic Security www.ti.com/security

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID www.ti-rfid.com

OMAP Applications Processors <u>www.ti.com/omap</u> TI E2E Community <u>e2e.ti.com</u>

Wireless Connectivity <u>www.ti.com/wirelessconnectivity</u>